



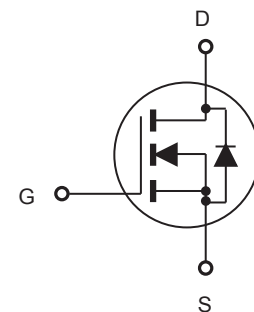
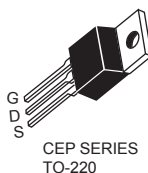
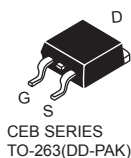
# CEP73A3G/CEB73A3G

## N-Channel Enhancement Mode Field Effect Transistor

PRELIMINARY

### FEATURES

- 30V, 62A,  $R_{DS(ON)} = 9m\Omega$  @  $V_{GS} = 10V$ .  
 $R_{DS(ON)} = 16m\Omega$  @  $V_{GS} = 4.5V$ .
- Super high dense cell design for extremely low  $R_{DS(ON)}$ .
- High power and current handling capability.
- Lead free product is acquired.
- TO-220 & TO-263 package.



### ABSOLUTE MAXIMUM RATINGS $T_C = 25^\circ\text{C}$ unless otherwise noted

| Parameter   | Symbol         | Limit      | Units               |
|---|----------------|------------|---------------------|
| Drain-Source Voltage  | $V_{DS}$       | 30         | V                   |
| Gate-Source Voltage   | $V_{GS}$       | $\pm 20$   | V                   |
| Drain Current-Continuous  | $I_D$          | 62         | A                   |
| Drain Current-Pulsed <sup>a</sup>   | $I_{DM}$       | 248        | A                   |
| Maximum Power Dissipation @ $T_C = 25^\circ\text{C}$<br>- Derate above $25^\circ\text{C}$ | $P_D$          | 75         | W                   |
|   |                | 0.52       | W/ $^\circ\text{C}$ |
| Operating and Store Temperature Range   | $T_J, T_{stg}$ | -55 to 175 | $^\circ\text{C}$    |

### Thermal Characteristics

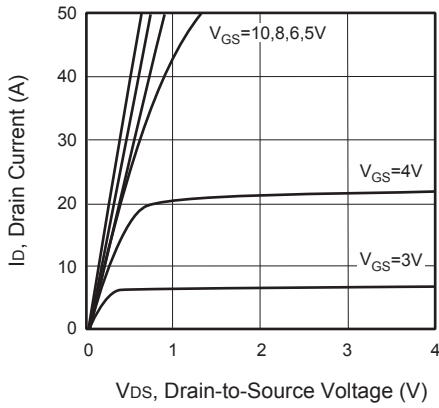
| Parameter                               | Symbol          | Limit | Units              |
|---|-----------------|-------|--------------------|
| Thermal Resistance, Junction-to-Case    | $R_{\theta JC}$ | 2     | $^\circ\text{C/W}$ |
| Thermal Resistance, Junction-to-Ambient | $R_{\theta JA}$ | 62.5  | $^\circ\text{C/W}$ |



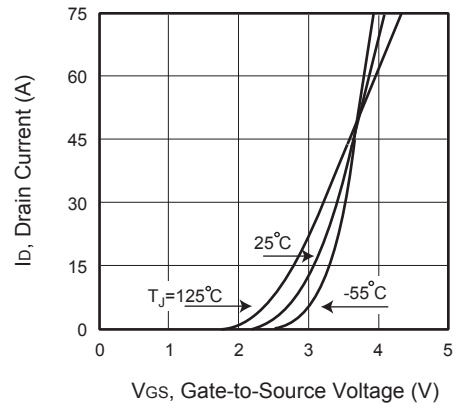
# CEP73A3G/CEB73A3G

## Electrical Characteristics $T_C = 25^\circ\text{C}$ unless otherwise noted

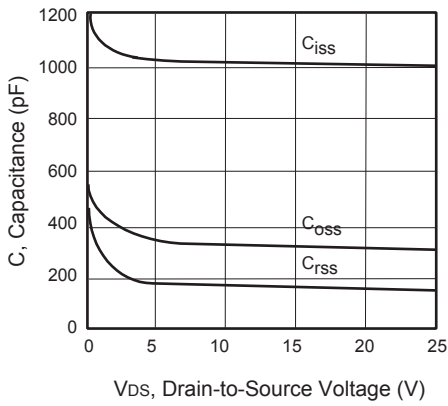
| Parameter  | Symbol       | Test Condition  | Min | Typ  | Max  | Units      |
|--|--------------|---|-----|------|------|------------|
| Off Characteristics  |              |   |     |      |      |            |
| Drain-Source Breakdown Voltage   | $BV_{DSS}$   | $V_{GS} = 0V, I_D = 250\mu A$                                   | 30  |      |      | V          |
| Zero Gate Voltage Drain Current  | $I_{DSS}$    | $V_{DS} = 30V, V_{GS} = 0V$                                     |     |      | 1    | $\mu A$    |
| Gate Body Leakage Current, Forward   | $I_{GSSF}$   | $V_{GS} = 20V, V_{DS} = 0V$                                     |     |      | 100  | nA         |
| Gate Body Leakage Current, Reverse   | $I_{GSSR}$   | $V_{GS} = -20V, V_{DS} = 0V$                                    |     |      | -100 | nA         |
| On Characteristics <sup>b</sup>  |              |   |     |      |      |            |
| Gate Threshold Voltage   | $V_{GS(th)}$ | $V_{GS} = V_{DS}, I_D = 250\mu A$                               | 1   |      | 3    | V          |
| Static Drain-Source On-Resistance  | $R_{DS(on)}$ | $V_{GS} = 10V, I_D = 40A$                                       |     | 7.5  | 9    | m $\Omega$ |
| On-Resistance  |              | $V_{GS} = 4.5V, I_D = 20A$                                      |     | 11   | 16   | m $\Omega$ |
| Forward Transconductance   | $g_{FS}$     | $V_{DS} = 10V, I_D = 30A$                                       |     | 22   |      | S          |
| Dynamic Characteristics <sup>c</sup>   |              |   |     |      |      |            |
| Input Capacitance  | $C_{iss}$    | $V_{DS} = 15V, V_{GS} = 0V,$<br>$f = 1.0\text{ MHz}$            |     | 1005 |      | pF         |
| Output Capacitance   | $C_{oss}$    |   |     | 265  |      | pF         |
| Reverse Transfer Capacitance   | $C_{rss}$    |   |     | 170  |      | pF         |
| Switching Characteristics <sup>c</sup>   |              |   |     |      |      |            |
| Turn-On Delay Time   | $t_{d(on)}$  | $V_{DD} = 15V, I_D = 10A,$<br>$V_{GS} = 10V, R_{GEN} = 1\Omega$ |     | 16   | 32   | ns         |
| Turn-On Rise Time  | $t_r$        |   |     | 9    | 18   | ns         |
| Turn-Off Delay Time  | $t_{d(off)}$ |   |     | 35.5 | 71   | ns         |
| Turn-Off Fall Time   | $t_f$        |   |     | 9    | 18   | ns         |
| Total Gate Charge  | $Q_g$        | $V_{DS} = 15V, I_D = 10A,$<br>$V_{GS} = 10V$                    |     | 22   | 28.6 | nC         |
| Gate-Source Charge   | $Q_{gs}$     |   |     | 3    |      | nC         |
| Gate-Drain Charge  | $Q_{gd}$     |   |     | 7    |      | nC         |
| Drain-Source Diode Characteristics and Maximum Ratings   |              |   |     |      |      |            |
| Drain-Source Diode Forward Current   | $I_S$        |   |     |      | 62   | A          |
| Drain-Source Diode Forward Voltage <sup>b</sup>  | $V_{SD}$     | $V_{GS} = 0V, I_S = 30A$  |     |      | 1.2  | V          |
| Notes :<br><sup>a</sup> Repetitive Rating : Pulse width limited by maximum junction temperature.<br><sup>b</sup> Pulse Test : Pulse Width $\leq 300\mu s$ , Duty Cycle $\leq 2\%$ .<br><sup>c</sup> Guaranteed by design, not subject to production testing. |              |   |     |      |      |            |



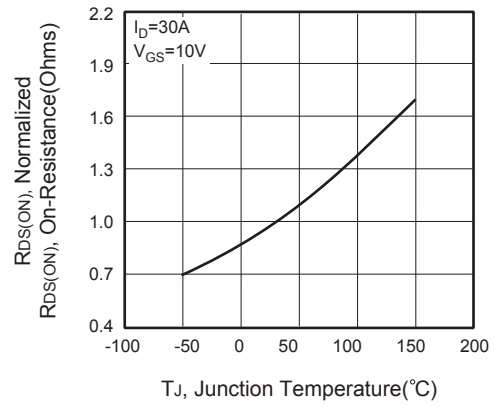
**Figure 1. Output Characteristics**



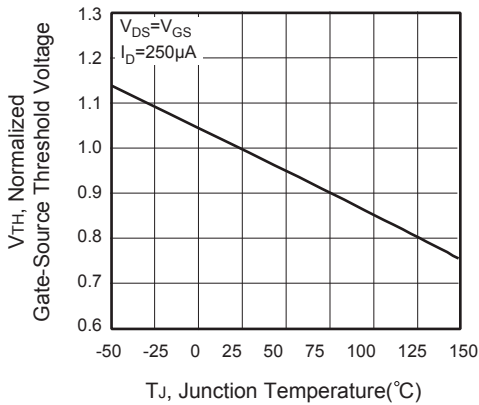
**Figure 2. Transfer Characteristics**



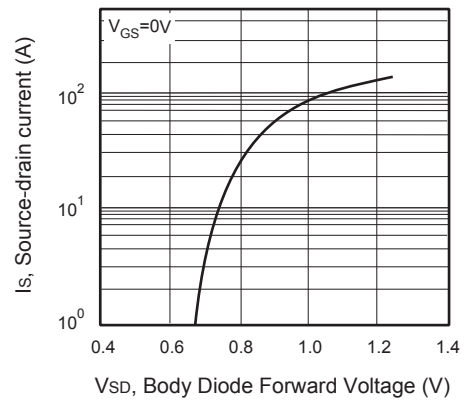
**Figure 3. Capacitance**



**Figure 4. On-Resistance Variation with Temperature**



**Figure 5. Gate Threshold Variation with Temperature**



**Figure 6. Body Diode Forward Voltage Variation with Source Current**



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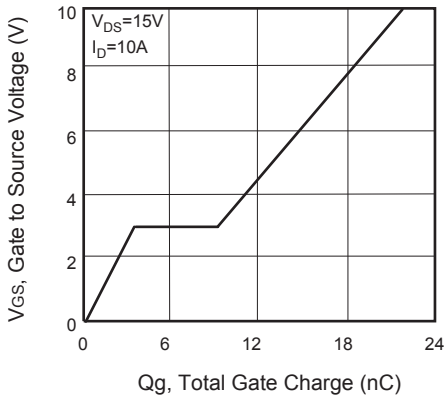


Figure 7. Gate Charge

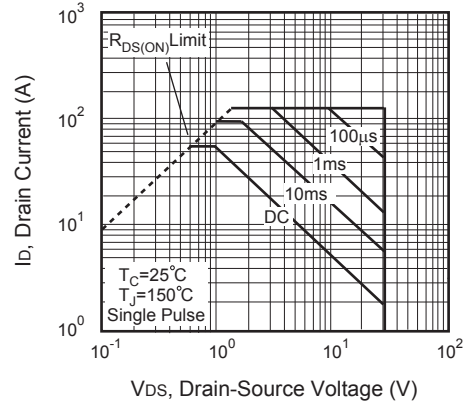


Figure 8. Maximum Safe Operating Area

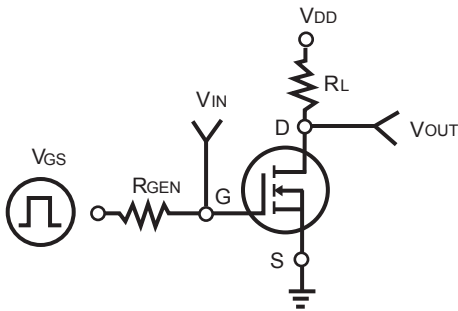


Figure 9. Switching Test Circuit

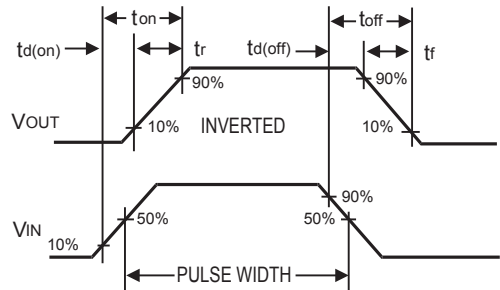


Figure 10. Switching Waveforms

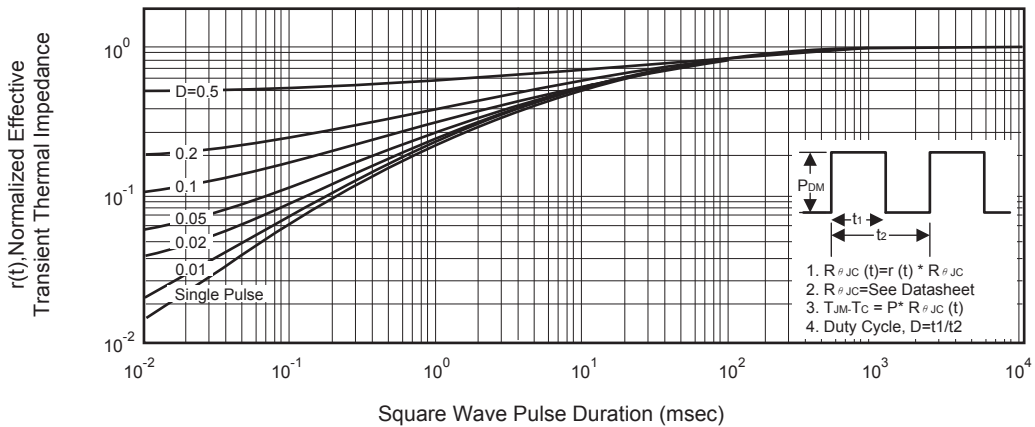


Figure 11. Normalized Thermal Transient Impedance Curve